

## **STE250NS10**

## N-channel 100V - 0.0045Ω - 220A - ISOTOP STripFET™ Power MOSFET

### **General features**

| Туре       | V <sub>DSS</sub> | R <sub>DS(on)</sub> | I <sub>D</sub> |
|------------|------------------|---------------------|----------------|
| STE250NS10 | 100V             | <0.0055Ω            | 220A           |

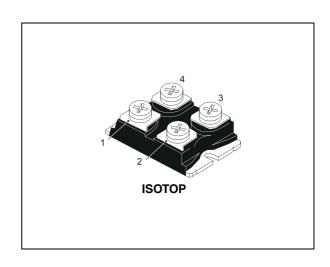
- Standard threshold drive
- 100% avalanche tested

### **Description**

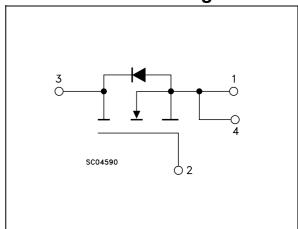
This Power MOSFET is the latest development of STMicroelectronics unique "Single Feature Size<sup>TM</sup>" strip-based process. The resulting transistor shows extremely high packing density for low on-resistance, rugged avalanche characteristics and less critical alignment steps therefore a remarkable manufacturing reproducibility.

## **Applications**

■ Switching application



### Internal schematic diagram



#### **Order codes**

| Part number | Marking  | Package | Packaging |  |
|-------------|----------|---------|-----------|--|
| STE250NS10  | E250NS10 | ISOTOP  | Tube      |  |

Contents STE250NS10

## **Contents**

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STE250NS10 Electrical ratings

## 1 Electrical ratings

Table 1. Absolute maximum ratings

| Symbol                         | Parameter   | Value      | Unit |  |
|--------------------------------|---|------------|------|--|
| V <sub>DS</sub>                | Drain-source voltage (v <sub>gs</sub> = 0)          | 100        | V    |  |
| V <sub>GS</sub>                | Gate- source voltage                                | ±20        | V    |  |
| I <sub>D</sub>                 | Drain current (continuos) at T <sub>C</sub> = 25°C  | 220        | Α    |  |
| I <sub>D</sub>                 | Drain current (continuos) at T <sub>C</sub> = 100°C | 156        | Α    |  |
| I <sub>DM</sub> <sup>(1)</sup> | Drain current (pulsed)                              | 880        | Α    |  |
| P <sub>TOT</sub>               | Total dissipation at T <sub>C</sub> = 25°C          | 500        | W    |  |
|                                | Derating factor                                     | 4          | W/°C |  |
| dv/dt <sup>(2)</sup>           | Peak diode recovery voltage slope                   | 3.5        | V/ns |  |
| V <sub>ISO</sub>               | Insulation winthstand voltage (DC)                  | 2500       | V    |  |
| T <sub>J</sub>                 | Operating junction temperature                      | 150        | °C   |  |
| T <sub>stg</sub>               | Storage temperature                                 | -55 to 150 |      |  |

<sup>1.</sup> Pulse width limited by safe operating area

Table 2. Thermal data

| R <sub>thj-case</sub> | Thermal resistance junction-case Max    | 0.25 | °CW |
|-----------------------|---|------|-----|
| R <sub>thj-a</sub>    | Thermal resistance junction-ambient Max | 50   | °CW |

Table 3. Avalanche characteristics

| Symbol          | Parameter   | Value | Unit |
|-----------------|---|-------|------|
| I <sub>AS</sub> | Avalanche current, repetitive or not-repetitive (pulse width limited by Tj Max) | 220   | Α    |
| E <sub>AS</sub> | Single pulse avalanche energy (starting Tj=25°C, Id=lar, Vdd=64V)               | 800   | mJ   |

<sup>2.</sup>  $I_{SD} \leq 220A$ , di/dt  $\leq 200A/\mu s$ ,  $V_{DD} \leq V_{(BR)DSS}$ ,  $T_j \leq T_{JMAX}$ 

Electrical characteristics STE250NS10

## 2 Electrical characteristics

( $T_{CASE}$ =25°C unless otherwise specified)

Table 4. On/off states

| Symbol               | Parameter                                       | Test conditions  | Min. | Тур.   | Max.   | Unit |
|----------------------|---|--|------|--------|--------|------|
| V <sub>(BR)DSS</sub> | Drain-source<br>Breakdown voltage               | I <sub>D</sub> = 1 mA, V <sub>GS</sub> = 0             | 100  |        |        | V    |
|                      | Zero gate voltage                               | V <sub>DS</sub> = Max rating                           |      |        | 50     | μΑ   |
| I <sub>DSS</sub>     | Drain current (V <sub>GS</sub> = 0)             | V <sub>DS</sub> = Max rating,<br>T <sub>C</sub> =125°C |      |        | 500    | μΑ   |
| I <sub>GSS</sub>     | Gate-body leakage current (V <sub>DS</sub> = 0) | V <sub>GS</sub> = ± 20V                                |      |        | ±400   | nA   |
| V <sub>GS(th)</sub>  | Gate threshold voltage                          | $V_{DS} = V_{GS}, I_{D} = 250 \mu A$                   | 2    | 3      | 4      | V    |
| R <sub>DS(on)</sub>  | Static drain-source on resistance               | V <sub>GS</sub> = 10V, I <sub>D</sub> = 125A           |      | 0.0045 | 0.0055 | Ω    |

Table 5. Dynamic

| Symbol           | Parameter                    | Test conditions  | Min. | Тур. | Max. | Unit |
|------------------|------------------------------|--|------|------|------|------|
| 9 <sub>fs</sub>  | Forward transconductance     | V <sub>DS</sub> = 20V <sub>,</sub> I <sub>D</sub> =70A |      | 60   |      | S    |
| C <sub>iss</sub> | Input capacitance            |  |      | 31   |      | nF   |
| C <sub>oss</sub> | Output capacitance           | $V_{DS} = 25V, f = 1 \text{ MHz}, $<br>$V_{GS} = 0$    |      | 4.3  |      | nF   |
| C <sub>rss</sub> | Reverse transfer capacitance | $V_{GS} = 0$   |      | 1.2  |      | nF   |
| Qg               | Total gate charge            | .,   |      | 900  |      | nC   |
| $Q_{gs}$         | Gate-source charge           | $V_{DD} = 50V, I_{D} = 22A,$<br>$V_{GS} = 10V$         |      | 160  |      | nC   |
| $Q_{gd}$         | Gate-drain charge            | VGS - 101  |      | 330  |      | nC   |

Table 6. Switching times

| Symbol   | Parameter                                       | Test conditions   | Min. | Тур.              | Max. | Unit           |
|--|---|---|------|-------------------|------|----------------|
| t <sub>d(on)</sub><br>t <sub>r</sub>               | Turn-on delay time<br>Rise time                 | $V_{DD}$ =50 V, $I_{D}$ =125A, $R_{G}$ =4.7 $\Omega$ $V_{GS}$ = 10V (see Figure 13) |      | 110<br>380        |      | ns<br>ns       |
| t <sub>d(off)</sub>                                | Turn-off-delay time<br>Fall time                | $V_{DD}$ =50 V, $I_{D}$ =125A, $R_{G}$ =4.7 $\Omega$ $V_{GS}$ = 10V (see Figure 13) |      | 1100<br>300       |      | ns<br>ns       |
| t <sub>r(Voff)</sub> t <sub>f</sub> t <sub>c</sub> | Off-voltage rise time fall time cross-over time | $V_{DD}$ =80V, $I_{D}$ =220A, $R_{G}$ =4.7 $\Omega$ $V_{GS}$ =10V (see Figure 15)   |      | 950<br>330<br>600 |      | ns<br>ns<br>ns |

Table 7. Source drain diode

| Symbol   | Parameter  | Test conditions  | Min | Тур.                | Max | Unit          |
|--|--|--|-----|---------------------|-----|---------------|
| I <sub>SD</sub>  | Source-drain current   |  |     |                     | 220 | Α             |
| I <sub>SDM</sub> <sup>(1)</sup>                        | Source-drain current (pulsed)  |  |     |                     | 880 | Α             |
| V <sub>SD</sub> <sup>(2)</sup>                         | Forward on voltage   | $I_{SD} = 220A, V_{GS} = 0$  |     |                     | 1.5 | V             |
| t <sub>rr</sub><br>Q <sub>rr</sub><br>I <sub>RRM</sub> | Reverse recovery time Reverse recovery charge Reverse recovery current | $I_{SD} = 220A, V_{DD} = 30V$<br>di/dt = 100A/ $\mu$ s,<br>$T_j = 150$ °C<br>(see Figure 15) |     | 200<br>1.35<br>13.5 |     | ns<br>μC<br>A |

<sup>1.</sup> Pulse width limited by safe operating area.

<sup>2.</sup> Pulsed: Pulse duration = 300  $\mu s$ , duty cycle 1.5 %

Electrical characteristics STE250NS10

## 2.1 Electrical characteristics (curves)

Figure 1. Safe operating area

Figure 2. Thermal impedance

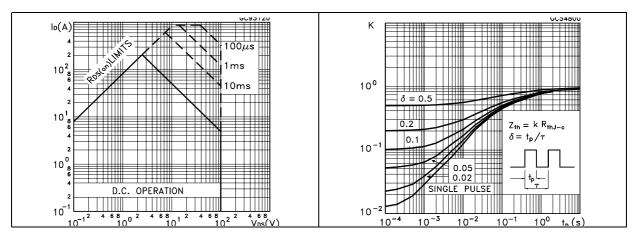


Figure 3. Output characterisics

Figure 4. Transfer characteristics

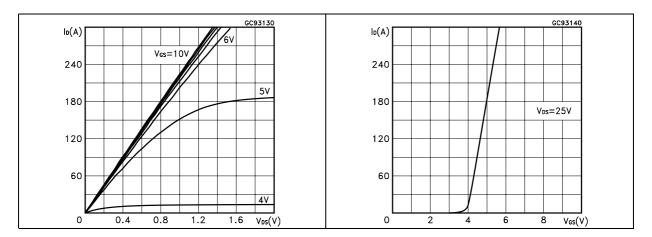


Figure 5. Transconductance

Figure 6. Static drain-source on resistance

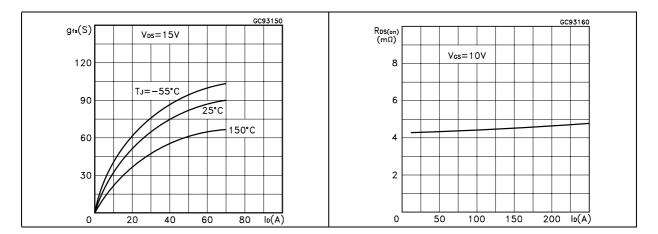


Figure 7. Gate charge vs gate-source voltage Figure 8. Capacitance variations

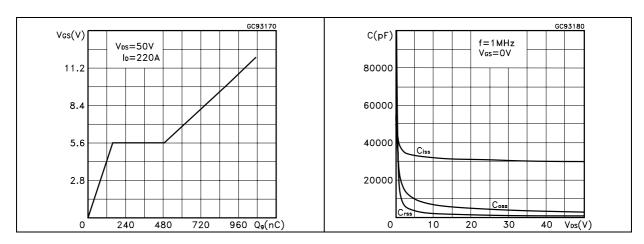


Figure 9. Normalized gate threshold voltage vs temperature

Figure 10. Normalized on resistance vs temperature

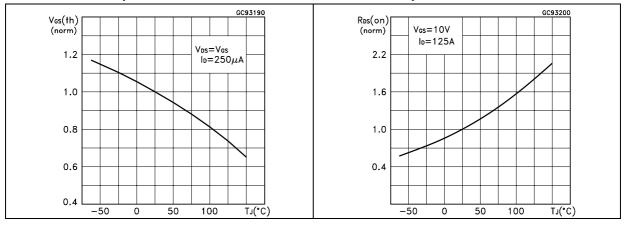
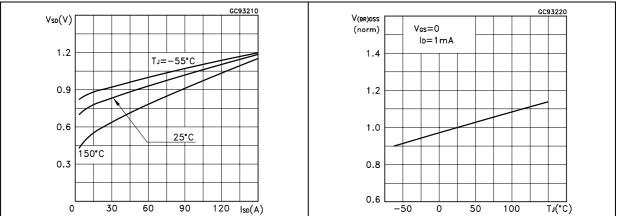


Figure 11. Source-drain diode forward characteristics

Figure 12. Normalized breakdown voltage vs temperature



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Test circuit STE250NS10

## 3 Test circuit

Figure 13. Switching times test circuit for resistive load

Figure 14. Gate charge test circuit

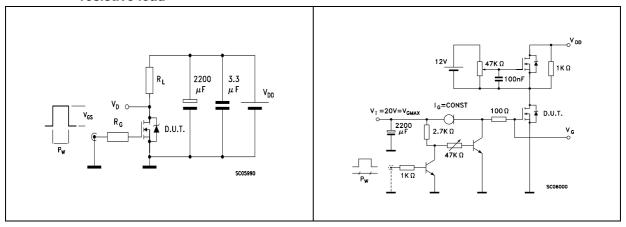


Figure 15. Test circuit for inductive load switching and diode recovery times

Figure 16. Unclamped Inductive load test circuit

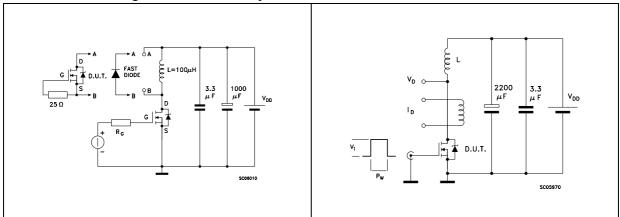
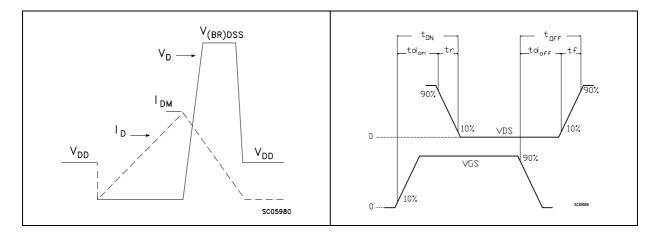


Figure 17. Unclamped inductive waveform

Figure 18. Switching time waveform

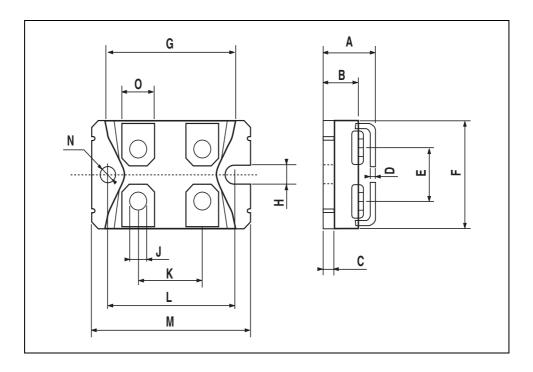


## 4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect . The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: <a href="https://www.st.com">www.st.com</a>

### **ISOTOP MECHANICAL DATA**

| DIM.   |       | mm   |      |       | inch |       |
|--------|-------|------|------|-------|------|-------|
| Dilvi. | MIN.  | TYP. | MAX. | MIN.  | TYP. | MAX.  |
| А      | 11.8  |      | 12.2 | 0.466 |      | 0.480 |
| В      | 8.9   |      | 9.1  | 0.350 |      | 0.358 |
| С      | 1.95  |      | 2.05 | 0.076 |      | 0.080 |
| D      | 0.75  |      | 0.85 | 0.029 |      | 0.033 |
| E      | 12.6  |      | 12.8 | 0.496 |      | 0.503 |
| F      | 25.15 |      | 25.5 | 0.990 |      | 1.003 |
| G      | 31.5  |      | 31.7 | 1.240 |      | 1.248 |
| Н      | 4     |      |      | 0.157 |      |       |
| J      | 4.1   |      | 4.3  | 0.161 |      | 0.169 |
| K      | 14.9  |      | 15.1 | 0.586 |      | 0.594 |
| L      | 30.1  |      | 30.3 | 1.185 |      | 1.193 |
| М      | 37.8  |      | 38.2 | 1.488 |      | 1.503 |
| N      | 4     |      |      | 0.157 |      |       |
| 0      | 7.8   |      | 8.2  | 0.307 |      | 0.322 |



STE250NS10 Revision history

# 5 Revision history

Table 8. Revision history

| Date        | Revision | Changes                         |  |
|-------------|----------|---------------------------------|--|
| 21-Jun-2004 | 1        | Complete version                |  |
| 04-Oct-2006 | 2        | New template, no content change |  |

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